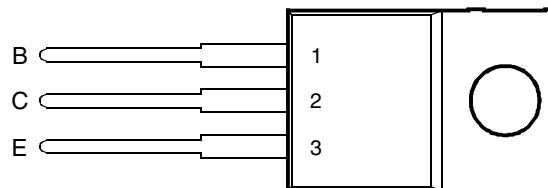


- 7 A Continuous Collector Current
- 15 A Peak Collector Current
- 60 W at 25°C Case Temperature

TO-220 PACKAGE
(TOP VIEW)

Pin 2 is in electrical contact with the mounting base.

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absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	BU406 BU407	V_{CBO}	400 330	V
Collector-emitter voltage ($V_{BE} = -2$ V)	BU406 BU407	V_{CEX}	400 330	V
Collector-emitter voltage ($I_B = 0$)	BU406 BU407	V_{CEO}	200 150	V
Emitter-base voltage		V_{EB}	6	V
Continuous collector current		I_C	7	A
Peak collector current (see Note 1)		I_{CM}	15	A
Continuous base current		I_B	4	A
Continuous device dissipation at (or below) 25°C case temperature		P_{tot}	60	W
Operating junction temperature range		T_j	-55 to +150	°C
Storage temperature range		T_{stg}	-55 to +150	°C

NOTE 1: This value applies for $t_p \leq 10$ ms, duty cycle $\leq 2\%$.**PRODUCT INFORMATION**

electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$	$I_C = 30 \text{ mA}$ $I_B = 0$			140			V
I_{CES}	$V_{CE} = 400 \text{ V}$	$V_{BE} = 0$	BU406			5	mA
	$V_{CE} = 330 \text{ V}$	$V_{BE} = 0$	BU407			5	
	$V_{CE} = 250 \text{ V}$	$V_{BE} = 0$	BU406			0.1	
	$V_{CE} = 200 \text{ V}$	$V_{BE} = 0$	BU407			0.1	
	$V_{CE} = 250 \text{ V}$	$V_{BE} = 0$	$T_C = 150^\circ\text{C}$	BU406		1	
	$V_{CE} = 200 \text{ V}$	$V_{BE} = 0$	$T_C = 150^\circ\text{C}$	BU407		1	
I_{EBO}	$V_{EB} = 6 \text{ V}$ $I_C = 0$					1	mA
h_{FE}	$V_{CE} = 10 \text{ V}$	$I_C = 4 \text{ A}$	(see Notes 2 and 3)	12			
	$V_{CE} = 10 \text{ V}$	$I_C = 0.5 \text{ A}$		20			
$V_{CE(sat)}$	$I_B = 0.5 \text{ A}$	$I_C = 5 \text{ A}$	(see Notes 2 and 3)			1	V
$V_{BE(sat)}$	$I_B = 0.5 \text{ A}$	$I_C = 5 \text{ A}$	(see Notes 2 and 3)			1.2	V
f_t	$V_{CE} = 5 \text{ V}$	$I_C = 0.5 \text{ A}$	$f = 1 \text{ MHz}$	(see Note 4)		6	MHz
C_{ob}	$V_{CB} = 20 \text{ V}$	$I_E = 0$	$f = 1 \text{ MHz}$			60	pF

NOTES: 2. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.
 3. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.
 4. To obtain f_t the $[h_{FE}]$ response is extrapolated at the rate of -6 dB per octave from $f = 1 \text{ MHz}$ to the frequency at which $[h_{FE}] = 1$.

thermal characteristics

PARAMETER	MIN	TYP	MAX	UNIT
$R_{\theta,JC}$ Junction to case thermal resistance			2.08	°C/W
$R_{\theta,JA}$ Junction to free air thermal resistance			70	°C/W

inductive-load-switching characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_s Storage time	$I_C = 5 \text{ A}$	$I_{B(end)} = 0.5 \text{ A}$	(see Figures 1 and 2)		2.7		μs
$t_{(off)}$ Turn off time						750	ns

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

PRODUCT INFORMATION

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 Specifications are subject to change without notice.

PARAMETER MEASUREMENT INFORMATION

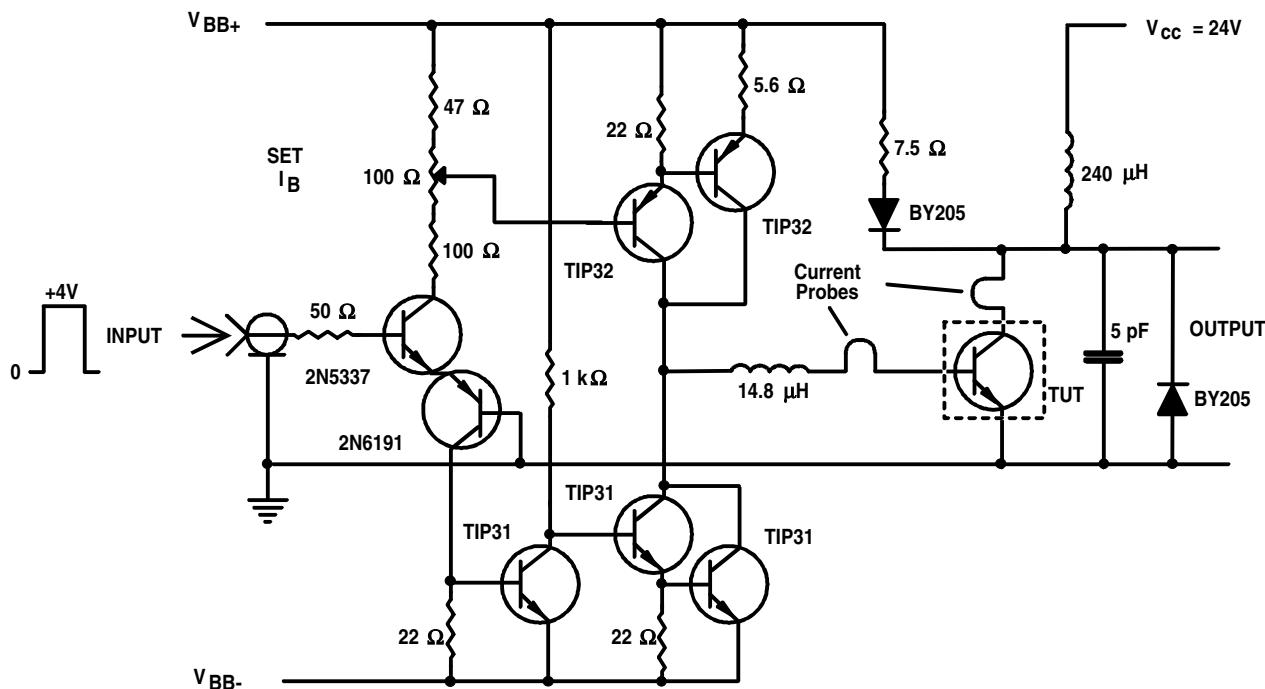


Figure 1. Inductive-Load Switching Test Circuit

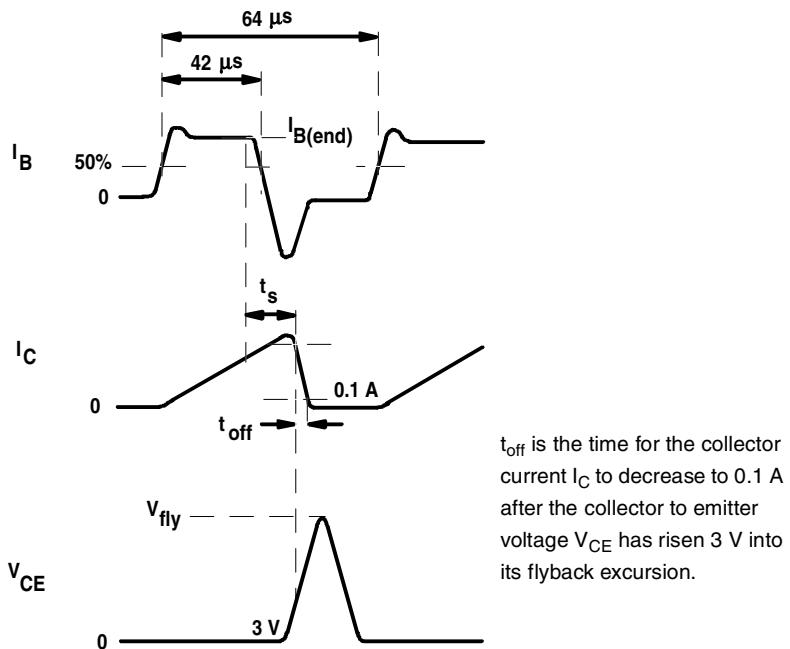


Figure 2. Inductive-Load Switching Waveforms

PRODUCT INFORMATION

TYPICAL CHARACTERISTICS

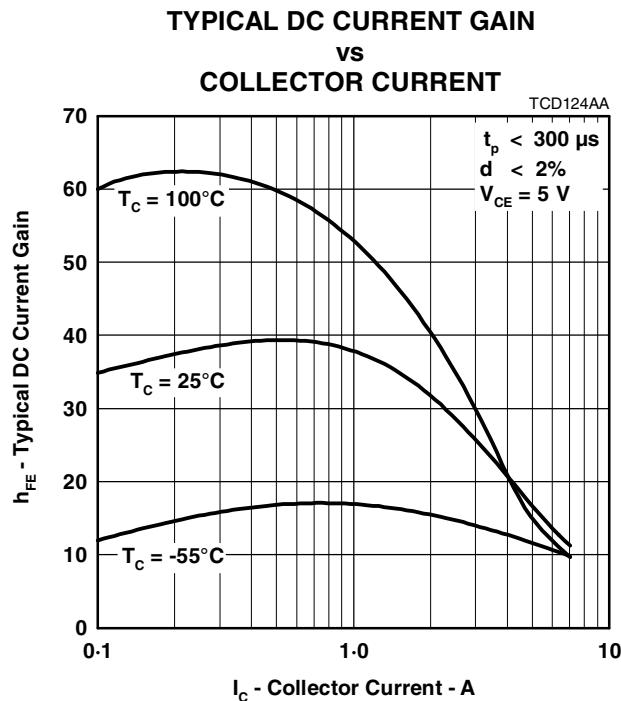


Figure 3.

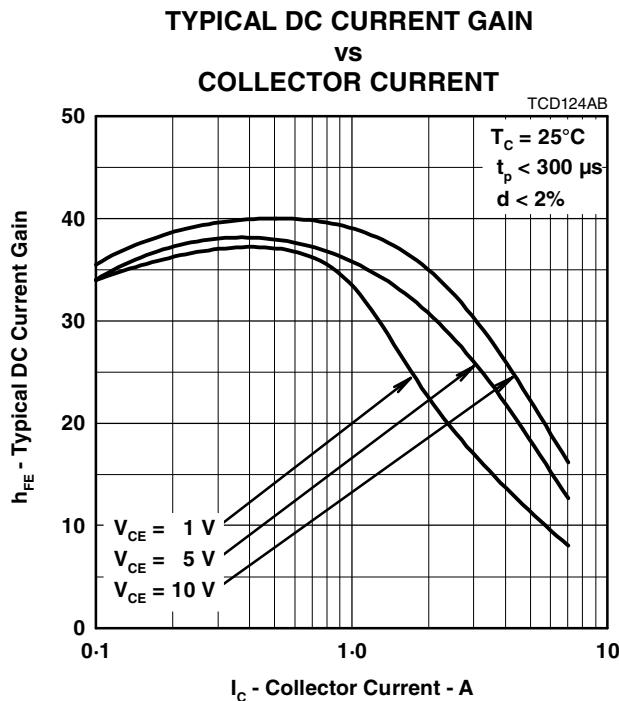


Figure 4.

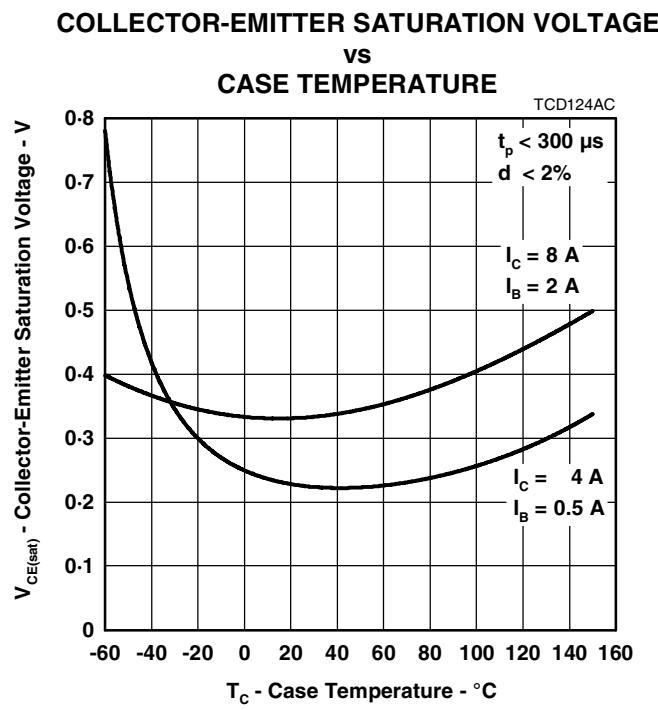


Figure 5.

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MAXIMUM SAFE OPERATING REGIONS

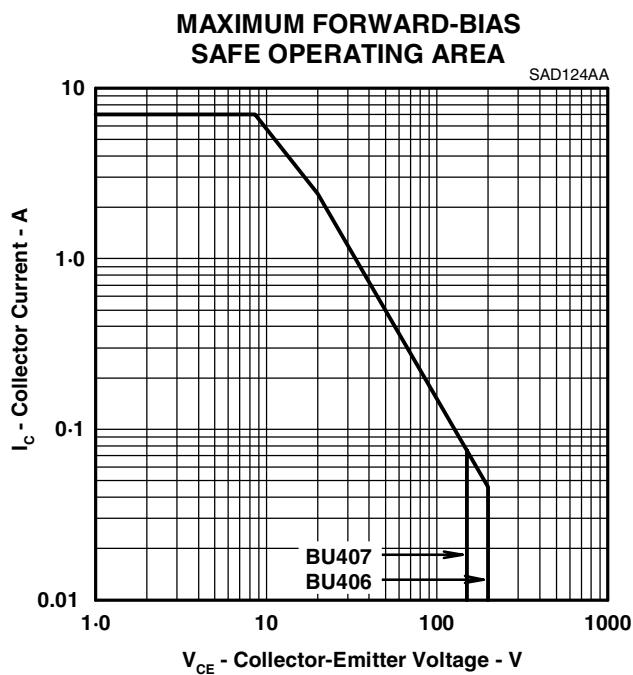


Figure 6.

PRODUCT INFORMATION

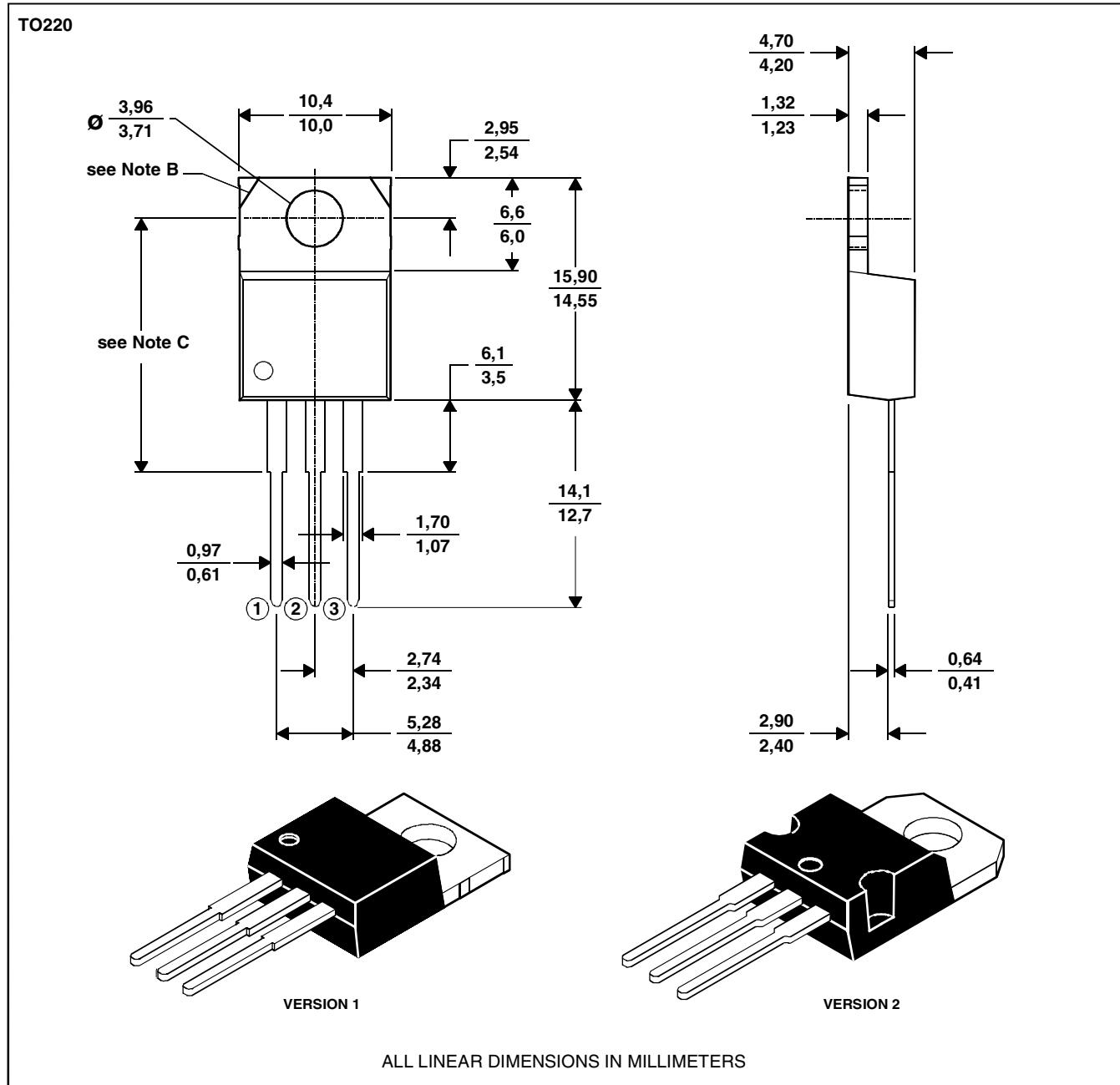
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MECHANICAL DATA

TO-220

3-pin plastic flange-mount package

This single-in-line package consists of a circuit mounted on a lead frame and encapsulated within a plastic compound. The compound will withstand soldering temperature with no deformation, and circuit performance characteristics will remain stable when operated in high humidity conditions. Leads require no additional cleaning or processing when used in soldered assembly.



NOTES: A. The centre pin is in electrical contact with the mounting tab.
 B. Mounting tab corner profile according to package version.
 C. Typical fixing hole centre stand off height according to package version.
 Version 1, 18.0 mm. Version 2, 17.6 mm.

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